

AMENDMENT TRANSMITTAL FORM

In re Application of: Liang-Chy Chien et al. Examiner: Tai V. Duong
 Serial No.: 10/553,326
 Filed: October 14, 2005 Group Art Unit: 2871
 For: **METHOD OF PLASMA BEAM BOMBARDMENT OF ALIGNING FILMS FOR LIQUID CRYSTALS**

Mail Stop Amendment
 Commissioner for Patents
 Alexandria, VA 22313-1450



Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ Small entity status of this application under 37 CFR §1.9 and §1.27 has been established by a verified statement previously submitted.
- ☒ No additional fee is required.

The fee has been calculated as shown below:

	Column 1 Claims Remaining After Amend- ment		Column 2 Highest No. Previously Paid For	Column 3 Present Extra Claims	Small Entity Rate	Small Entity Additional Fee	or	Other Than Small Entity Rate	Other Than Small Entity Additional Fee
Total*	37	-	50	= 0	x \$ 26	\$		x \$ 52	\$ 0.00
Indep.*	2	-	3	= 0	x \$ 110	\$		x \$ 220	\$
Multiple Dep. Claim					+ \$ 195			+ \$ 390	\$
TOTAL ADDITIONAL FEES					TOTAL \$		or		TOTAL \$ 0.00

* If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

** If the *Highest Number Previously Paid For* IN THIS SPACE is less than 20, write "20" in this space.

*** If the *Highest Number Previously Paid For* IN THIS SPACE is less than 3, write "3" in this space.

The *Highest Number Previously Paid For* (Total or Independent) is the highest number found from the equivalent box in Col. 1 of a prior amendment or the number of claims originally filed.

- ☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
 A DUPLICATE OF THIS SHEET IS ATTACHED.
- ☐ A check in the amount of \$ _____ is attached
- ☒ The Commissioner is hereby authorized to charge any additional fees which might be required or credit any overpayment of fees with regard to the attached documents to Deposit Account No. 08-3150.
- ☐ Any patent application processing fees under 37 CFR §1.17.

Date: 11/4/09

By: Daniel J. Hudak, Jr.
 Daniel J. Hudak, Jr. Registration No. 47,669

HUDAK, SHUNK & FARINE CO. L.P.A.
 2020 Front Street, Suite 307
 Cuyahoga Falls, OH 44221
 Telephone: 330-535-2220
 Fax: 330-535-1435



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Liang-Chy Chien et al.

Examiner: Tai V. Duong

Serial No: 10/553,326

Group Art Unit: 2871

Filed: October 14, 2005

Date: November 4, 2009

For: **METHOD OF PLASMA BEAM BOMBARDMENT OF ALIGNING
FILMS FOR LIQUID CRYSTALS**

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING


Sir,

The undersigned hereby certifies that the attached **TRANSMITTAL FORM, REQUEST FOR CONTINUED EXAMINATION TRANSMITTAL, CHECK NO. 19061 FOR \$405.00, AMENDMENT TRANSMITTAL FORM, AMENDMENT "B" AND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT WITH FORM PTO-1449 AND THREE REFERENCES** were mailed to Mail Stop RCE, Commissioner for Patents, Alexandria, VA 22313, with sufficient first-class postage, no special handling, on November 4, 2009 before 5:00 PM, thereby ensuring that such document(s) will be in the hands of the U.S. Postal Service by the close of business this day.

The Commissioner is hereby authorized to charge any fees which might be required or credit any overpayment of fees with regard to the attached document(s) to Deposit Account No. 08-3150.

Respectfully submitted,

HUDAK, SHUNK & FARINE CO. L.P.A.


Daniel J. Hudak, Jr.
Registration No. 47,669

DJHjr/js
2020 Front Street, Suite 307
Cuyahoga Falls, OH 44221
330-535-2220

Attorney Docket No.: KENT-B-PCT-US